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www.vishay.com

Vishay Semiconductors

ADD-A-PAK Generation VII Power Modules Thyristor/Diode and Thyristor/Thyristor, 27 A



PRODUCT SUMMARY					
I _{T(AV)} or I _{F(AV)}	27 A				
Type	Modules - Thyristor, Standard				

MECHANICAL DESCRIPTION

The ADD-A-PAK Generation VII, new generation of ADD-A-PAK module, combines the excellent thermal performances obtained by the usage of exposed direct bonded copper substrate, with advanced compact simple package solution and simplified internal structure with minimized number of interfaces.

FEATURES

- High voltage
- Industrial standard package
- UL approved file E78996
- Low thermal resistance
- · Designed and qualified for industrial level
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

BENEFITS

- Excellent thermal performances obtained by the usage of exposed direct bonded copper substrate
- Up to 1600 V
- · High surge capability
- · Easy mounting on heatsink

ELECTRICAL DESCRIPTION

These modules are intended for general purpose high voltage applications such as high voltage regulated power supplies, lighting circuits, temperature and motor speed control circuits, UPS and battery charger.

MAJOR RATINGS AND CHARACTERISTICS						
SYMBOL	CHARACTERISTICS	VALUES	UNITS			
I _{T(AV)} or I _{F(AV)}	85 °C	27				
I _{O(RMS)}	As AC switch	60	Α			
I _{TSM.}	50 Hz	400	A			
I _{FSM}	60 Hz	420				
l ² t	50 Hz	800	kA ² s			
I - 1	60 Hz	730	KA-S			
I ² √t		8000	kA²√s			
V _{RRM}	Range	400 to 1600	V			
T _{Stg}		-40 to 125	°C			
T _J		-40 to 125	°C			

VS-VSKT26.., VS-VSKH26.., VS-VSKN26.. Series

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ELECTRICAL SPECIFICATIONS

VOLTAGE RATINGS								
TYPE NUMBER	VOLTAGE CODE	V _{RRM} , MAXIMUM REPETITIVE PEAK REVERSE VOLTAGE V	V _{RSM} , MAXIMUM NON-REPETITIVE PEAK REVERSE VOLTAGE V	V _{DRM} , MAXIMUM REPETITIVE PEAK OFF-STATE VOLTAGE, GATE OPEN CIRCUIT V	I _{RRM,} I _{DRM} AT 125 °C mA			
	04	400	500	400				
	06	600	700	600				
	08	800	900	800				
VS-VSK.26	10	1000	1100	1000	15			
	12	1200	1300	1200				
	14	1400	1500	1400				
	16	1600	1700	1600				

ON-STATE CONDUCTION						
PARAMETER	SYMBOL		TEST CONDITIONS		VALUES	UNITS
Maximum average on-state current (thyristors)	I _{T(AV)}	180° conduction, half sine wave,		27		
Maximum average forward current (diodes)	I _{F(AV)}	$T_C = 85 ^{\circ}C$			21	
Maximum continuous RMS on-state current, as AC switch	I _{O(RMS)}	•	or or (RMS)			Α
		t = 10 ms	No voltage		400	
Maximum peak, one-cycle non-repetitive	I _{TSM}	t = 8.3 ms	reapplied	Sinusoidal half wave,	420	
on-state or forward current	or I _{FSM}	t = 10 ms	100 % V _{RRM}	initial $T_J = T_J$ maximum	335	
	1 OW	t = 8.3 ms	reapplied	. 0 0	350	
		t = 10 ms	No voltage		800	- A ² s
Maximum I ² t for fusing	l ² t	t = 8.3 ms	reapplied	latital T. T. association	730	
	I-ſ	t = 10 ms	100 % V _{RRM}	Initial $T_J = T_J$ maximum	560	
		t = 8.3 ms	reapplied		510	
Maximum $I^2\sqrt{t}$ for fusing	I ² √t ⁽¹⁾		t = 0.1 ms to 10 ms, no voltage reapplied $T_J = T_J$ maximum		8000	A²√s
Maximum value or threshold voltage	V (2)	Low level (3)	$T_J = T_J$ maximum		0.86	V
Maximum value of threshold voltage	V _{T(TO)} (2)	High level (4)	ıj= ıjınaxın	IUIII	1.09	V
Maximum value of on-state	r _t ⁽²⁾	Low level (3)	T _ T movin	a.i.ma	9.58	mΩ
slope resistance	It (=)	High level (4)	$T_J = T_J \text{ maximum}$		7.31	11122
Maximum peak on-state or forward voltage	V_{TM}	$I_{TM} = \pi \times I_{T(AV)}$	T _J = 25 °C		1.65	V
Maximum peak on-state or forward voltage	V _{FM}	$I_{FM} = \pi \times I_{F(AV)}$	1j = 25 C		1.05	V
Maximum non-repetitive rate of rise of turned on current	dl/dt	$T_J = 25$ °C, from 0.67 V_{DRM} , $I_{TM} = \pi \times I_{T(AV)}$, $I_q = 500$ mA, $t_r < 0.5$ μ s, $t_p > 6$ μ s		150	A/µs	
Maximum holding current	I _H	T _J = 25 °C, anode supply = 6 V, resistive load, gate open circuit			200	mA
Maximum latching current	IL	T _J = 25 °C, and	ode supply = 6 '	V, resistive load	400	

Notes

⁽¹⁾ I^2t for time $t_x = I^2\sqrt{t} \times \sqrt{t_x}$

⁽²⁾ Average power = $V_{T(TO)} \times I_{T(AV)} + r_t \times (I_{T(RMS)})^2$

^{(3) 16.7 %} $\times \pi \times I_{AV} < I < \pi \times I_{AV}$

 $^{^{(4)}~}I>\pi~x~I_{AV}$



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TRIGGERING					
PARAMETER	SYMBOL	TEST CO	NDITIONS	VALUES	UNITS
Maximum peak gate power	P_{GM}			10	W
Maximum average gate power	P _{G(AV)}			2.5	VV
Maximum peak gate current	I _{GM}			2.5	Α
Maximum peak negative gate voltage	- V _{GM}			10	V
		T _J = -40 °C	Anode supply = 6 V resistive load	4.0	
Maximum gate voltage required to trigger	V _{GT}	T _J = 25 °C		2.5	
		T _J = 125 °C		1.7	
		T _J = -40 °C		270	
Maximum gate current required to trigger	I _{GT}	T _J = 25 °C	Anode supply = 6 V resistive load	150	mA
		T _J = 125 °C	resistive load	80	
Maximum gate voltage that will not trigger	V_{GD}	T _J = 125 °C, rated V _{DRM} applied		0.25	V
Maximum gate current that will not trigger	I_{GD}	$T_J = 125$ °C, rated V_{DRM} applied		6	mA

BLOCKING							
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS			
Maximum peak reverse and off-state leakage current at V _{RRM} , V _{DRM}	I _{RRM,} I _{DRM}	T _J = 125 °C, gate open circuit	15	mA			
Maximum RMS insulation voltage	V _{INS}	50 Hz	3000 (1 min) 3600 (1 s)	V			
Maximum critical rate of rise of off-state voltage	dV/dt	$T_J = 125$ °C, linear to 0.67 V_{DRM}	1000	V/µs			

THERMAL AND MECHANICAL SPECIFICATIONS						
PARAMETER		SYMBOL	SYMBOL TEST CONDITIONS		UNITS	
Junction operating and storage temperature range		T _J , T _{Stg}		-40 to 125	°C	
Maximum internal thermal resistance, junction to case per leg		R _{thJC}	DC operation 0.76		900	
Typical thermal resistance, case to heatsink per module		R _{thCS}	Mounting surface flat, smooth and greased	0.1	°C/W	
Mounting torque ± 10 % to heatsink busbar			A mounting compound is recommended and the torque should be rechecked after a period of	4	Nm	
			3 hours to allow for the spread of the compound.	3	NIII	
Approximate weight				75	g	
Approximate weight				2.7	oz.	
Case style		JEDEC®	AAP GEN VII	(TO-240AA)		

ΔR CONDUCTION PER JUNCTION											
DEVICES		SINE HALF WAVE CONDUCTION					CTANGUL	AR WAVE C	CONDUCTION	ON	UNITS
DEVICES	180°	120°	90°	60°	30°	180°	120°	90°	60°	30°	UNITS
VSK.26	0.212	0.258	0.330	0.466	0.72	0.166	0.276	0.357	0.482	0.726	°C/W

Note

• Table shows the increment of thermal resistance R_{thJC} when devices operate at different conduction angles than DC

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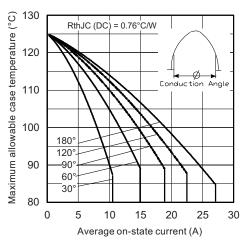


Fig. 1 - Current Ratings Characteristics

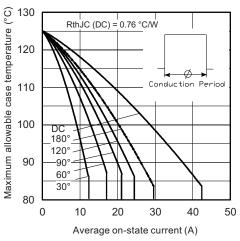


Fig. 2 - Current Ratings Characteristics

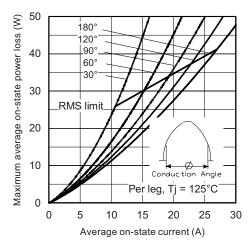


Fig. 3 - On-State Power Loss Characteristics

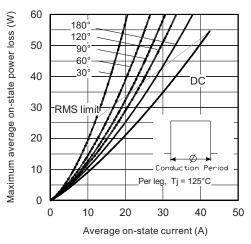
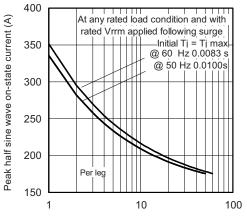


Fig. 4 - On-State Power Loss Characteristics



Number of equal amplitude half cycle current pulses (N)

Fig. 5 - Maximum Non-Repetitive Surge Current

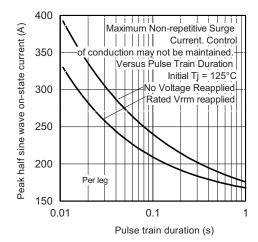


Fig. 6 - Maximum Non-Repetitive Surge Current

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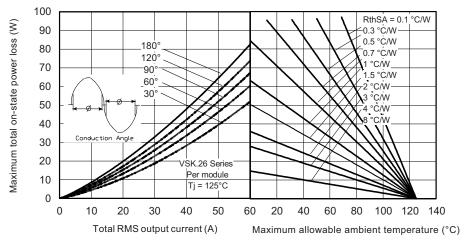


Fig. 7 - On-State Power Loss Characteristics

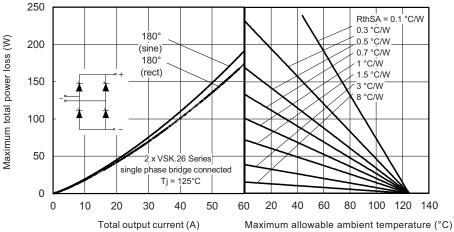


Fig. 8 - On-State Power Loss Characteristics

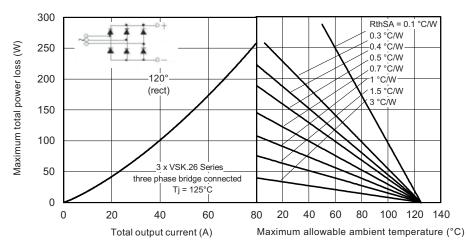


Fig. 9 - On-State Power Loss Characteristics

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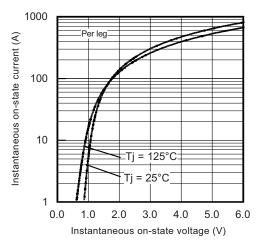


Fig. 10 - On-State Voltage Drop Characteristics

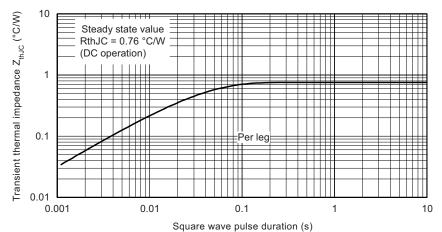


Fig. 11 - Thermal Impedance Z_{thJC} Characteristics

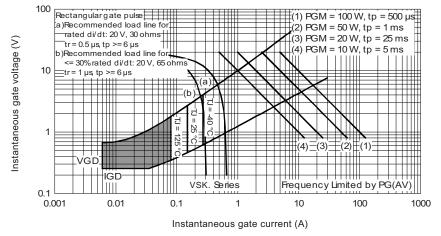
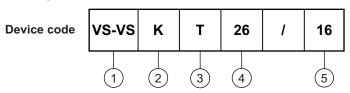


Fig. 12 - Gate Characteristics

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ORDERING INFORMATION TABLE

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1 - Vishay Semiconductors product

2 - Module type

- Circuit configuration (see Circuit Configuration table)

4 - Current code (26 A)

5 - Voltage code (see Voltage Ratings table)

Note

To order the optional hardware go to <u>www.vishay.com/doc?95172</u>

CIRCUIT CONFIGURATION	ON	
CIRCUIT DESCRIPTION	CIRCUIT CONFIGURATION CODE	CIRCUIT DRAWING
Two SCRs doubler circuit	Т	VSKT (1) 1 (2) (2) (3) (4) (3) (7) (6)
SCR/diode doubler circuit, positive control	Н	VSKH (1) (1) (1) (2) (2) (3) (3) (4) (5) (4) (5)
SCR/diode doubler circuit, negative control	L	VSKL (2) (2) (2) (2) (3) (6) (6)
SCR/diode common anodes	N	VSKN (2) (2) (3) (3) (3) (3) (4) (5) (4) (5)

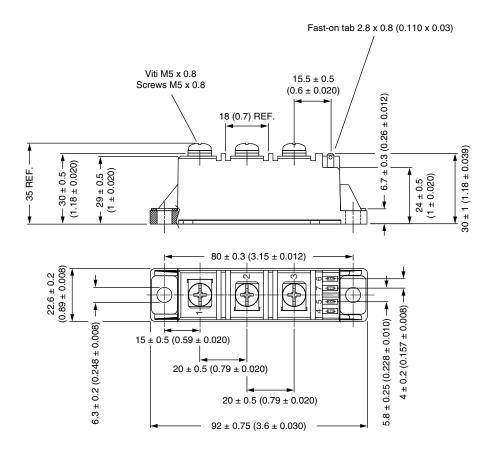
LINKS TO RELATED DOCUMENTS				
Dimensions	www.vishay.com/doc?95368			



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ADD-A-PAK Generation VII - Thyristor

DIMENSIONS in millimeters (inches)





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